



0.10 CAB 0.05 C

> PACKAGE DUTLINE

> > 1.65

0.65 PITCH

BOTTOM VIEW

DATE 15 JUN 2018

NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DIMENSION 6 APPLIES TO PLATED TERMINALS AND IS MEASURED BETWEEN 0.15 AND 0.30MM FROM THE TERMINAL TIP.
- 4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.
- 5. THIS DEVICE CONTAINS WETTABLE FLANK
 DESIGN FEATURES TO AID IN FILLET
 FORMATION ON THE LEADS DURING MOUNTING.

	MILLIMETERS			
DIM	MIN.	N□M.	MAX.	
Α	0.70	0.75	0.80	
A1			0.05	
A3	0.20 REF			
Α4	0.10			
۵	0.25	0.30	0.35	
D	1.90	2.00	2.10	
D2	1.50	1.60	1.70	
Ы	1.90	2.00	2.10	
E2	0.80	0.90	1.00	
ω	0.65 BSC			
K	0.25 REF			
٦	0.25	0.30	0.35	
L3	0.05 REF			

GENERIC MARKING DIAGRAM*



M = Month Code

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " •", may or may not be present. Some products may not follow the Generic Marking.

DOCUMENT NUMBER:	98AON79327G	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	WDFNW6 2x2, 0.65P		PAGE 1 OF 1	

PLATED SURFACE

DETAIL B

RECOMMENDED
MOUNTING FOOTPRINT

ALTERNATE CONSTRUCTION

2.30

∟6X 0.48

0.95

-6X 0.35

onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.